

N-Channel Enhancement Mode MOSFET

Feature Pin Description

• 40V/58A

 $R_{DS(ON)} = 6.5 \text{ m}\Omega(typ.) \text{ @VGS} = 10V$ $R_{DS(ON)} = 8.9 \text{ m}\Omega(typ.) \text{ @VGS} = 10V$

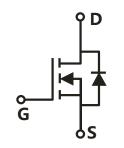
- 100% Avalanche Tested
- 100% DVDS
- Reliable and Rugged
- Halogen Free and Green Devices Available (RoHS Compliant)

Applications

- Switching application
- Li-battery protection
- DC-DC
- Motor control



TO-252-2L TO-251-3L TO-251-3S



Single N-Channel MOSFET

Ordering and Marking Information



Package Code

D: TO-252-2L U: TO-251-3L V:TO-251-3S

Date Code XYMXXXXXX

Note: HUAYI halogen free products contain molding compounds/die attach materials and 100% matte tin plate Termi-Nation finish; which are fully compliant with RoHS. HUAYI halogen free products meet or exceed the halogen free require-ments of IPC/JEDEC J-STD-020 for MSL classification at halogen free peak reflow temperature. HUAYI defines "Green" to mean halogen free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

HUAYI reserves the right to make changes, corrections, enhancements, modifications, and improvements to this pr



-oduct and/or to this document at any time without notice.

Absolute Maximum Ratings

Symbol	Parameter	Rating	Unit	
Common Ra	tings (Tc=25°C Unless Otherwise Noted)			
VDSS	Drain-Source Voltage		40	V
Vgss	Gate-Source Voltage		±20	V
TJ	Junction Temperature Range			°C
Тѕтс	Storage Temperature Range		-55 to 175	°C
ls	Source Current-Continuous(Body Diode)	Tc=25°C	58	А
Mounted on	Large Heat Sink			I
I DM	Pulsed Drain Current *	Tc=25°C	174	А
	Outing a Paris Out of	Tc=25°C	58	А
lσ	Continuous Drain Current	Tc=100°C	40	А
_		Tc=25°C	55	W
Po	Maximum Power Dissipation	Tc=100°C	27	W
R ₀ JC	Thermal Resistance, Junction-to-Case		2.74	°C/W
R _{eJA}	Thermal Resistance, Junction-to-Ambient **		75	°C/W
Eas	Single Pulsed-Avalanche Energy ***	L=0.3mH	60	mJ

Note:

- * Repetitive rating; pulse width limited by max.junction temperature.
- ** Surface mounted on 1in2 FR-4 board.
- *** Limited by TJmax , starting TJ=25°C, L = 0.3mH, Rg= 25Ω , Vgs =10V.

Electrical Characteristics (Tc = 25°C Unless Otherwise Noted)

Cumbal	Doromotor	Test Conditions		HYG090N04LS1		11:4:4	
Symbol	Parameter			Min	Тур.	Max	Unit
Static Cha	racteristics						
BVDSS	Drain-Source Breakdown Voltage	V _{GS} =0V,I _{DS} =2	250µA	40	-	-	V
Ipss	VDS=40V,VGS=0V		-	-	1	μA	
IDSS	Drain-to-Source Leakage Current		TJ=125°C	-	-	50	μΑ
VGS(th)	Gate Threshold Voltage	V _{DS} =V _{GS} , I _{DS} =250µA		1	2.0	3	V
Igss	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$		-	-	±100	nA
RDS(ON)	Drain-Source On-State Resistance	V _{GS} =10V,I _{DS} =20A		-	6.5	7.8	mΩ
RDS(ON)	Drain-Source On-State Resistance	V _{GS} =4.5V,I _{DS} =20A			8.9	10.6	mΩ
Diode Cha	Diode Characteristics						
VsD	Diode Forward Voltage	IsD=20A,Vgs=0V		-	0.92	1.2	V
trr	Reverse Recovery Time	lan 200 dlan/dt 1000/ug		-	13.9	-	ns
Qrr	Reverse Recovery Charge	- Isb=20A,dIsb/dt=100A/μs		-	5.7	-	nC



Electrical Characteristics (Cont.) (Tc =25°C Unless Otherwise Noted)

Cumbal	Danamatan	Tank Oam dikinga	HY	HYG090N04LS1		
Symbol	Parameter	Test Conditions		Тур.	Max	Unit
Dynamic	Characteristics	•				
Rg	Gate Resistance	V _{GS} =0V,V _{DS} =0V,F=500KHz	-	2.0	-	Ω
Ciss	Input Capacitance	Vgs=0V,	-	824	-	
Coss	Output Capacitance	V _{DS} = 25V,	-	160	-	pF
Crss	Reverse Transfer Capacitance	Frequency=500KHz	-	12.6	-	
td(ON)	Turn-on Delay Time		-	7.5	-	
Tr	Turn-on Rise Time	$V_{DD}=20V,R_{G}=4\Omega,$	-	31	-	
td(OFF)	Turn-off Delay Time	Ips=20A,Vgs=10V	-	14.7	-	ns
Tf	Turn-off Fall Time		-	1.9	-	
Gate Cha	rge Characteristics					
0	Total Gate Charge(V _{GS} =10V)		-	12.3	-	
Q_g	Total Gate Charge(V _{GS} =4.5V)			5.9		~C
Qgs	Gate-Source Charge	V _{DS} =32V, I _{DS} =20A	-	3.37	-	nC
Qgd	Gate-Drain Charge		-	1.57	-	
V _{plateau}	Gate plateau voltage		-	3.75	-	V

Note: *Pulse test, pulse width \leq 300us, duty cycle \leq 2%



Typical Operating Characteristics

Figure 1: Power Dissipation

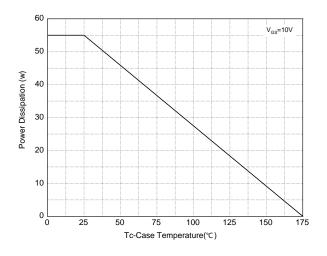


Figure 3: Safe Operation Area

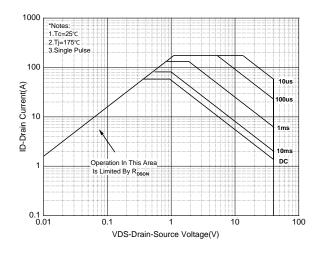


Figure 5: Output Characteristics

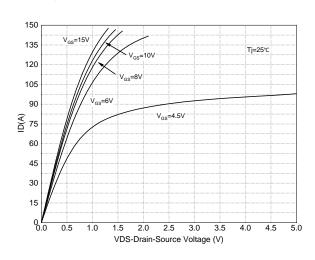


Figure 2: Drain Current

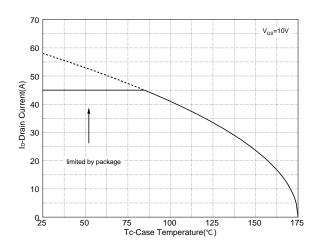


Figure 4: Thermal Transient Impedance

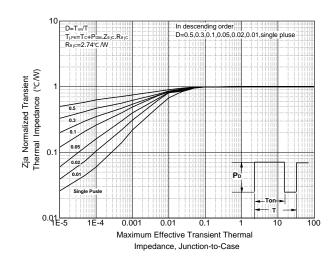
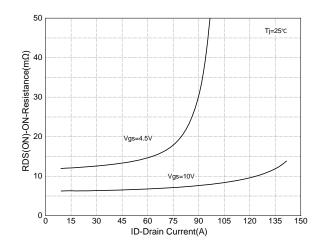


Figure 6: Drain-Source On Resistance





Typical Operating Characteristics(Cont.)

Figure 7: On-Resistance vs. Temperature

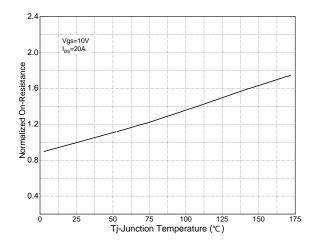


Figure 8: Source-Drain Diode Forward

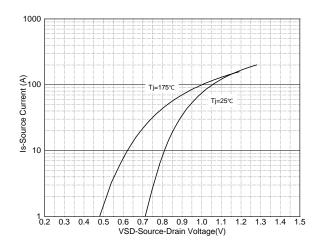


Figure 9: Capacitance Characteristics

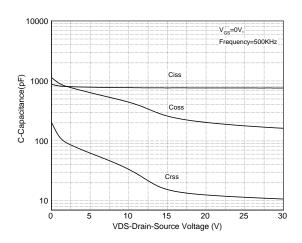
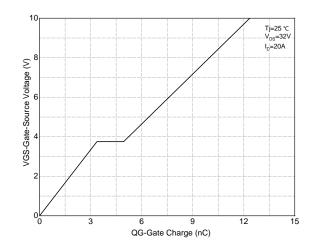
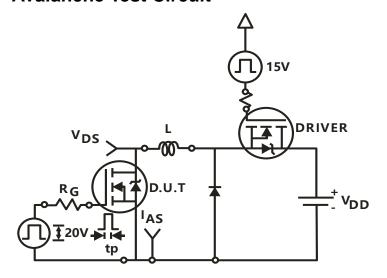


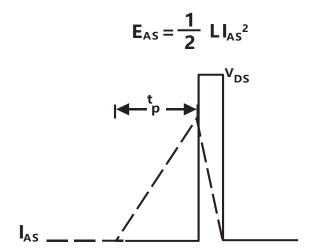
Figure 10: Gate Charge Characteristics



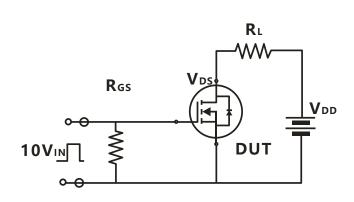


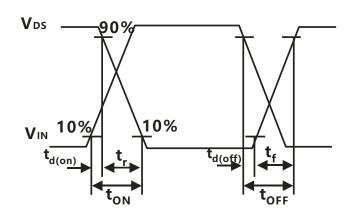
Avalanche Test Circuit



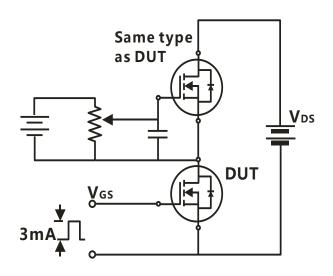


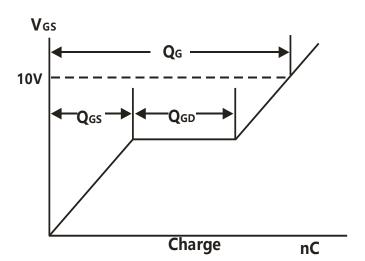
Switching Time Test Circuit





Gate Charge Test Circuit





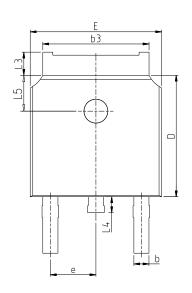


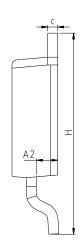
Device Per Unit

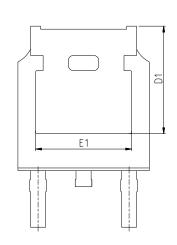
Package Type	Unit	Quantity
TO-252-2L	Tube	75
TO-252-2L	Reel	2500
TO-251-3L	Tube	75
TO-251-3S	Tube	75

Package Information

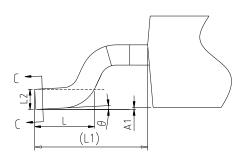
TO-252-2L







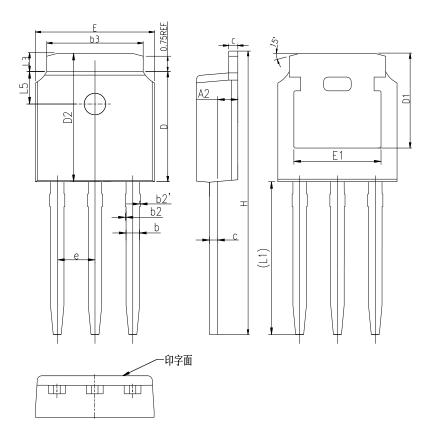




COMMON DIMENSIONS				
SYMBOL	mm			
3 I WIDOL	MIN	NOM	MAX	
Α	2.20	2.30	2.40	
A1	0.00	-	0.12	
A2	0.97	1.07	1.17	
b	0.68	0.78	0.90	
b3	5.20	5.33	5.46	
С	0.43	0.53	0.61	
D	5.98	6.10	6.22	
D1		5.30REF	•	
Е	6.40	6.60	6.73	
E1	4.63	-	-	
е		2.286BS0		
Н	9.40	10.10	10.50	
L	1.38	1.50	1.75	
L1		2.90REF	•	
L2	0.51BSC			
L3	0.88	-	1.28	
L4	0.50	-	1.00	
L5	1.65	1.80	1.95	
θ	0°	-	8°	



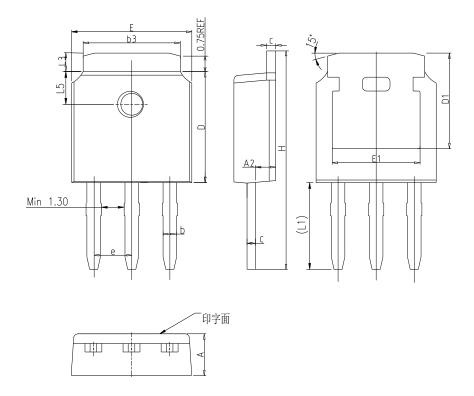
TO-251-3L



COMMON DIMENSIONS				
SYMBOL	mm			
STIVIBOL	MIN	NOM	MAX	
А	2.20	2.30	2.38	
A2	0.97	1.07	1.17	
b	0.68	0.78	0.90	
b2	0.00	0.04	0.10	
b2'	0.00	0.04	0.10	
b3	5.20	5.33	5.46	
С	0.43	0.53	0.61	
D	5.98	6.10	6.22	
D1	4.30	5.30	6.00	
D2	6.92	7.12	7.32	
Е	6.40	6.60	6.73	
E1	4.63	-	-	
е	2.286BSC			
Н	16.22	16.52	16.82	
L1	9.15	9.40	9.65	
L3	0.88	1.02	1.28	
L5	1.65	1.80	1.95	



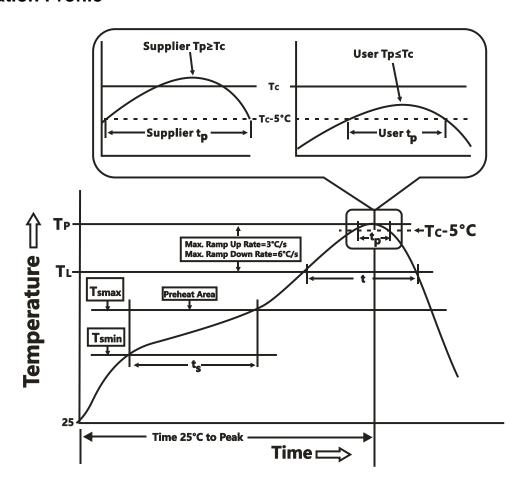
TO-251-3S



COMMON DIMENSIONS				
SYMBOL	mm			
	MIN	NOM	MAX	
А	2.20	2.30	2.38	
A2	0.97	1.07	1.17	
b	0.68	0.78	0.90	
b3	5.20	5.33	5.46	
С	0.43	0.53	0.60	
D	5.98	6.10	6.22	
D1		5.30REF		
E	6.40	6.60	6.73	
E1	4.63	-	-	
е		2.286BSC		
Н	10.00	11.22	11.44	
L1	3.90	4.10	4.30	
L3	0.88	1.02	1.28	
L5	1.65	1.80	1.95	



Classification Profile



Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly				
	Preheat & Soak					
Temperature min (T _{smin})	100 °C	150 °C				
Temperature max (T _{smax})	150 °C	200 °C				
Time (Tsmin to Tsmax) (t _s)	60-120 seconds	60-120 seconds				
Average ramp-up rate	3 °C/second max.	3°C/second max.				
(T _{smax} to T _P)	5 C/second max.	5 C/second max.				
Liquidous temperature (T _L)	183 °C	217 °C				
Time at liquidous (t _L)	60-150 seconds	60-150 seconds				
Peak package body Temperature	See Classification Temp in table 1	SacClassification Tampin table 2				
(T _p)*	See Classification Temp in table 1	SeeClassification Tempin table 2				
Time (t _P)** within 5°C of the specified	20**	20**				
classification temperature (T _c)	20** seconds	30** seconds				
Average ramp-down rate (Tpto Tsmax)	6 °C/second max.	6 °C/second max.				
Time 25°C to peak temperature	6 minutes max.	8 minutes max.				

^{*}Tolerance for peak profile Temperature (Tp) is defined as a supplier minimum and a user maximum.

^{**} Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

HYG090N04LS1D/U/V



Table 1.SnPb Eutectic Process – Classification Temperatures (Tc)

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2.Pb-free Process – Classification Temperatures (Tc)

Package	Volume mm ³	Volume mm³	Volume mm³
Thickness	<350	350-2000	≥2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	168/500 Hrs, Bias @ 150°C
HTGB	JESD-22, A108	168 /500 Hrs, Vgs100% @ 150°C
PCT	JESD-22, A102	96 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	250/500 Cycles, -55°C~150°C

Customer Service

Worldwide Sales and Service: sales@hymexa.com Technical Support:Technology@hymexa.com

Huayi Microelectronics Co., Ltd.

No.8928, Shangji Road, Economic and Technological Development Zone, Xi'an, China

TEL: (86-029) 86685706 FAX: (86-029) 86685705 E-mail: sales@hymexa.com Web net: http://www.hymexa.com/